Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	1	"6618543".pn. and "1.6"	US-PGPUB; USPAT	OR	ON	2005/01/12 10:24
L4	15	(Fujita.in. or Ishii.in. or Tamura.in. or Kurata.in. or Sharp.as.) and ((high adj transmit\$6) or (absorpt\$6 adj coefficient) or waveguid\$3 or lightguid\$3 or ((wave or light) adj guid\$3)) and ((bake or baked or baking or cure or cured or curing or heat\$3 or harden\$3) with (polymer\$2 or polyimide or (poly adj imide) or resin\$3) with (vacuum or torr or (reduc\$3 adj pressure)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 11:29
L5	15	(Fujita.in. or Ishii.in. or Tamura.in. or Kurata.in. or Sharp.as.) and ((high adj transmit\$6) or (absorpt\$6 adj coefficient) or waveguid\$3 or lightguid\$3 or ((wave or light) adj guid\$3)) and ((bake or baked or baking or cure or cured or curing or heat\$3 or	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 11:29
		harden\$3) with (polymer\$2 or polyimide or (poly adj imide) or resin\$3 or PIX3400 or (PIX adj "3400") or HD6100 or (HD adj "6100")) with (vacuum or torr or (reduc\$3 adj pressure)))				
L6	15	(Fujita.in. or Ishii.in. or Tamura.in. or Kurata.in. or Sharp.as.) and ((high adj transmit\$6) or (absorpt\$6 adj coefficient) or waveguid\$3 or lightguid\$3 or ((wave or light) adj guid\$3)) and ((bake or baked or baking or cure or cured or curing or heat\$3 or harden\$3) with (polymer\$2 or polyimide or (poly adj imide) or resin\$3 or PIX3400 or (PIX adj "3400") or HD6100 or (HD adj "6100")) with (vacuum or torr or ((reduc\$3 or low\$3) near2 pressure)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 11:30
L7	5	(Fujita.in. or Ishii.in. or Tamura.in. or Kurata.in. or Sharp.as.) and ((high adj transmit\$6) or (absorpt\$6 adj coefficient) or waveguid\$3 or lightguid\$3 or ((wave or light) adj guid\$3)) and (PIX3400 or (PIX adj "3400") or HD6100 or (HD adj "6100"))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 11:30

L8	5	(Fujita.in. or Ishii.in. or Tamura.in. or Kurata.in. or Sharp.as.) and (PIX3400 or (PIX adj "3400") or HD6100 or (HD adj "6100"))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2005/01/12 11:30
L9	3631	((427/163.1,163.2) or (385/129, 130,131,132,143)).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/12 11:30
L10	468	(427/350).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/12 11:31
L11 .	6360	(427/372.2,379,385.5).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/12 11:31
L12	2014	(528/310,322).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/12 11:31
L13	14838	(((427/163.1,163.2) (385/129,130, 131,132,143))).CCLS.) ((427/350). CCLS.) ((427/372.2,379,385.5). CCLS.) ((528/310,322).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/01/12 11:31
L14	0	(((427/163.1,163.2) or (385/129, 130,131,132,143)).CCLS.) and ((427/350).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/01/12 11:32
L15	49	(((427/163.1,163.2) or (385/129, 130,131,132,143)).CCLS.) and ((427/372.2,379,385.5).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/01/12 11:32
L16	1	(((427/163.1,163.2) or (385/129, 130,131,132,143)).CCLS.) and ((528/310,322).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/01/12 11:32
L17	12	((427/372.2,379,385.5).CCLS.) and ((528/310,322).CCLS.)	US-PGPUB; USPAT	OR	ON-	2005/01/12 11:32
L18	0	((427/350).CCLS.) and ((528/310, 322).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/01/12 11:32
L19	54	((427/350).CCLS.) and ((427/372.2, 379,385.5).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/01/12 11:32

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L20	3923	((((427/163.1,163.2) or (385/129, 130,131,132,143)).CCLS.)) ((427/350).CCLS.) ((427/372.2,379, 385.5).CCLS.) ((528/310,322).CCLS.)) and (waveguid\$3 or (wave adj guid\$3) or lightguid\$3 or (light adj guid\$3)) and (polyimide or (poly adj imide)) and ((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) with (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) with (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure)))	US-PGPUB; USPAT	OR	ON	2005/01/12 11:34
L21	3923	((((427/163.1,163.2) or (385/129, 130,131,132,143))).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/01/12 11:34
	, "	((427/350).CCLS.) ((427/372.2,379, 385.5).CCLS.) ((528/310,322).CCLS.			*.	
)) and (waveguid\$3 or (wave adj	, 1.1* xc0		, <u>.</u> .	
	*	guid\$3) or lightguid\$3 or (light adj guid\$3)) and (polyimide or (poly adj		1.		
		imide)) and ((heat\$3 or bake or	y.			0.0
		baked or baking or oven or cure or			-	
		cured or curing or dry\$3 or harden\$3) with (polymer\$2 or				
		resin\$3 or polyimide or (poly adj	٠. وزو			~ .
	- 3:	imide) or core) with (vacuum or torr or pascal or Pa or ((low\$4 or				en Propinsi di Propinsi di Propinsi di Propinsi di Pr
	*	below\$4 or reduc\$5) near2				1 1 1 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2
		pressure)))	English E		- 18	× 120
L22	3923	(((427/163.1,163.2) or (385/129, 130,131,132,143)).CCLS.) ((427/350).CCLS.) ((427/372.2,379, 385.5).CCLS.) ((528/310,322).CCLS.)) and (waveguid\$\$3 or (wave adj guid\$\$3) or lightguid\$\$3 or (light adj guid\$\$3)) and (polyimide or (poly adj imide)) and ((heat\$\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$\$3 or harden\$\$3) with (polymer\$\$2 or resin\$\$3 or polyimide or (poly adj imide) or core) with (vacuum or torr or pascal or Pa or ((low\$\$4 or	US-PGPUB; USPAT	OR	ON	2005/01/12 11:35
		below\$4 or reduc\$5) near2 pressure)))				

L23	25	L13 and (waveguid\$3 or (wave adj guid\$3) or lightguid\$3 or (light adj guid\$3)) and (polyimide or (poly adj imide)) and ((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) with (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) with (vacuum or	US-PGPUB; USPAT	OR	ON	2005/01/12 11:51
		torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure)))				
L24	25	L13 and (waveguid\$3 or (wave adj guid\$3) or lightguid\$3 or (light adj guid\$3)) and (polyimide or (poly adj imide)) and ((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) with (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) with (vacuum or	US-PGPUB; USPAT	OR	ON	2005/01/12 11:36
	ů.	imide) or core) with (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure)))			w ·	
L25	152	(waveguid\$3 or (wave adj guid\$3) or lightguid\$3 or (light adj guid\$3)) and (polyimide or (poly adj imide)) and ((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) with (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) with (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure)))	US-PGPUB; USPAT	OR	ON	2005/01/12 11:37
L26	127	L25 not L24	US-PGPUB; USPAT_	OR	ON '	2005/01/12 11:37
L28	6	(waveguid\$3 or (wave adj guid\$3) or lightguid\$3 or (light adj guid\$3)) and (polyimide or (poly adj imide)) and ((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) with (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) with (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure)))	EPO; JPO; DERWENT; IBM_TDB	OR	ON .	2005/01/12 11:41

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L29	181	((polyimide or (poly adj imide)) and ((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) near6 (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) near7 (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure)))) not ((waveguid\$3 or (light adj guid\$3) or lightguid\$3 or (light adj guid\$3)) and (polyimide or (poly adj imide)) and ((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) with (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) with (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure))))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 11:41
L30	199	((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) near6 (polyimide or (poly adj imide)) near7 (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure)) with (coat\$3 or film or layer or deposit\$3 or core or apply\$3))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 11:42
L31	5	L30 and L13	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 11:42
L32	7	L13 and (waveguid\$3 or (wave adj guid\$3) or lightguid\$3 or (light adj guid\$3)) and ((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) near5 (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) near5 (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure)) with (coat\$3 or film or layer or deposit\$3 or apply\$3 or spincoat\$3 or core or waveguid\$4 or lightguid\$4 or guid\$4))	US-PGPUB; USPAT	OR	ON	2005/01/12 11:44

L33		(waveguid\$3 or (wave adj guid\$3) or lightguid\$3 or (light adj guid\$3)) and ((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) near6 (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) near6 (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure)) with (coat\$3 or	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 11:44
		film or layer or deposit\$3 or apply\$3 or spincoat\$3 or core or waveguid\$4 or lightguid\$4 or guid\$4))		_		
L34	298	((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) near6 (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) near6 (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure)) with (coat\$3 or film or layer or deposit\$3 or apply\$3 or spincoat\$3 or core or waveguid\$4 or lightguid\$4 or guid\$4)) same (transparen\$5 or absorb\$8 or absorp\$8 or (optical\$2 near2 (attenuat\$4 or loss)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 11:47
L35	7	(((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) near6 (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) near6 (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure)) with (coat\$3 or film or layer or deposit\$3 or apply\$3 or spincoat\$3 or core or waveguid\$4 or lightguid\$4 or guid\$4)) with (preferab\$5 or advantag\$6 or desir\$6)) and (polyimide or (poly adj imide))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 11:48
L36	9	((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) with (polyimide or (poly adj imide) or polymer\$2 or resin\$5) near7 (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure)) with (coat\$3 or film or layer or deposit\$3 or core or apply\$3)) same ((pressure near5 (depend\$5 or advantag\$8 or benefi\$7 or prefer\$6)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 11:49

L37	90	((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) with (polyimide or (poly adj imide)) near7 (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure))) same (torr or Pa or pascal or mm or mmHg)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2005/01/12 11:50
L38	15	(waveguid\$3 or (wave adj guid\$3) or lightguid\$3 or (light adj guid\$3)) and (polyimide or (poly adj imide)) and ((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) with (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) with (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure))) and ((absorp\$8 or absorb\$8) near2 (coefficient or (co adj efficient)))	US-PGPUB; USPAT	OR	ON	2005/01/12 11:52
L39		(waveguid\$3 or (wave adj guid\$3) or lightguid\$3 or (light adj guid\$3)) and (polyimide or (poly adj imide)) and ((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) with (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) with (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure))) and ((absorp\$8 or absorb\$8) near2 (coefficient or (co adj efficient)))	US-PGPUB; USPAT	OR	ON	2005/01/12 11:55
L40	0	(waveguid\$3 or (wave adj guid\$3) or lightguid\$3 or (light adj guid\$3)) and (polyimide or (poly adj imide)) and ((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) with (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) with (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure))) and ((absorp\$8 or absorb\$8) near2 (coefficient or	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 11:55
*		(co adj efficient)))		1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	1	

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L41		(polyimide or (poly adj imide)) same ((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) same (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) same (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure))) same ((absorp\$8 or absorb\$8) near2 (coefficient or (co adj efficient)))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 11:56
L42	2	(polyimide or (poly adj imide)) same ((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) same (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) same (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure))) same ((absorp\$8 or absorb\$8) near2 (coefficient or (co adj efficient)))	US-PGPUB; USPAT	OR	ON	2005/01/12 11:58
L43		(polyimide or (poly adj imide) or waveguide or lightguide or ((wave or light) adj guid\$4)) and (((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) same (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) same (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure))) same ((absorp\$8 or absorb\$8) near2 (coefficient or (co adj efficient))))	US-PGPUB; USPAT	OR	ON	2005/01/12 12:02
L44	5	L43 not L42	US-PGPUB; USPAT	OR	ON	2005/01/12 11:58
L45	8	(polyimide or (poly adj imide) or waveguide or lightguide or ((wave or light) adj guid\$4)) and (((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) with (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) with (decreas\$5 or lower\$4 or reduc\$5) with ((absorp\$8 or absorb\$8) near2 (coefficient or (co adj efficient)))))	US-PGPUB; USPAT	OR	ON	2005/01/12 12:01

L46	2	(polyimide or (poly adj imide) or waveguide or lightguide or ((wave or light) adj guid\$4)) and (((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) same (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) same (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure))) same ((absorp\$8 or	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 12:04
L47	2	absorb\$8) near2 (coefficient or (co adj efficient)))) (polyimide or (poly adj imide) or	EPO; JPO;	OR	ON	2005/01/12 12:03
		waveguide or lightguide or ((wave or light) adj guid\$4)) and (((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) with (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) with (decreas\$5 or lower\$4 or reduc\$5) with ((absorp\$8 or absorb\$8) near2 (coefficient or (co adj efficient)))))	DERWENT; IBM_TDB			2003/01/12 12:03
L48	26	(((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) with (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) with (decreas\$5 or lower\$4 or reduc\$5) with ((absorp\$8 or absorb\$8) near2 (coefficient or (co adj efficient)))))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 12:03
L49	121	(polyimide or (poly adj imide) or waveguide or lightguide or ((wave or light) adj guid\$4)) and (((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) with (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) with (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure)))) and ((absorp\$8 or absorb\$8) near2 (coefficient or (co adj efficient)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 12:07
L50	10	L49 and L13	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 12:06

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L51	1	(polyimide or (poly adj imide) or waveguide or lightguide or ((wave or light) adj guid\$4)) and (((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) with (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) with (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure)))) and ((absorp\$8 or absorb\$8) near2 (coefficient or (co adj efficient)))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 12:07
L52	5	(polyimide or (poly adj imide)) same (waveguide or lightguide or ((wave or light) adj guid\$4)) same ((absorp\$8 or absorb\$8) near2 (coefficient or (co adj efficient)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 12:09
L53	849	((absorp\$8 or absorb\$8) near2 (coefficient or (co adj efficient))) and (((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) same (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) same (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure))))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 12:11
L54	23	L53 and L13	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 12:10
L55	36	((absorp\$8 or absorb\$8) near2 (coefficient or (co adj efficient))) same (((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) same (polymer\$2 or resin\$3 or polyimide or (poly adj imide) or core) same (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure))))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 12:14
L56	34	L55 not L54	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 12:12

L57	64	((absorp\$8 or absorb\$8) near2 (coefficient or (co adj efficient))) same (((heat\$3 or bake or baked or baking or oven or cure or cured or curing or dry\$3 or harden\$3) near6 (vacuum or torr or pascal or Pa or ((low\$4 or below\$4 or reduc\$5) near2 pressure))))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 12:14
L58	1	L57 and L13	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 12:14
L59	63	L57 not L58	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/12 12:14